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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	AVR
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	6
Program Memory Size	1KB (512 x 16)
Program Memory Type	FLASH
EEPROM Size	64 x 8
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 4x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package	8-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/attiny13a-sshr

Features

- High Performance, Low Power AVR® 8-Bit Microcontroller
- Advanced RISC Architecture
 - 120 Powerful Instructions Most Single Clock Cycle Execution
 - 32 x 8 General Purpose Working Registers
 - Fully Static Operation
 - Up to 20 MIPS Througput at 20 MHz
- High Endurance Non-volatile Memory segments
 - 1K Bytes of In-System Self-programmable Flash program memory
 - 64 Bytes EEPROM
 - 64 Bytes Internal SRAM
 - Write/Erase Cycles: 10,000 Flash/100,000 EEPROM
 - Data retention: 20 Years at 85°C/100 Years at 25°C (see page 6)
 - Programming Lock for Self-Programming Flash & EEPROM Data Security
- Peripheral Features
 - One 8-bit Timer/Counter with Prescaler and Two PWM Channels
 - 4-channel, 10-bit ADC with Internal Voltage Reference
 - Programmable Watchdog Timer with Separate On-chip Oscillator
 - On-chip Analog Comparator
- Special Microcontroller Features
 - debugWIRE On-chip Debug System
 - In-System Programmable via SPI Port
 - External and Internal Interrupt Sources
 - Low Power Idle, ADC Noise Reduction, and Power-down Modes
 - Enhanced Power-on Reset Circuit
 - Programmable Brown-out Detection Circuit with Software Disable Function
 - Internal Calibrated Oscillator
- I/O and Packages
 - 8-pin PDIP/SOIC: Six Programmable I/O Lines
 - 10-pad MLF: Six Programmable I/O Lines
 - 20-pad MLF: Six Programmable I/O Lines
- Operating Voltage:
 - 1.8 5.5V
- Speed Grade:
 - 0 4 MHz @ 1.8 5.5V
 - 0 10 MHz @ 2.7 5.5V
 - 0 20 MHz @ 4.5 5.5V
- Industrial Temperature Range
- Low Power Consumption
 - Active Mode:
 - 190 μA at 1.8 V and 1 MHz
 - Idle Mode:
 - 24 µA at 1.8 V and 1 MHz



8-bit **AVR**®
Microcontroller with 1K Bytes
In-System
Programmable
Flash

ATtiny13A

Summary

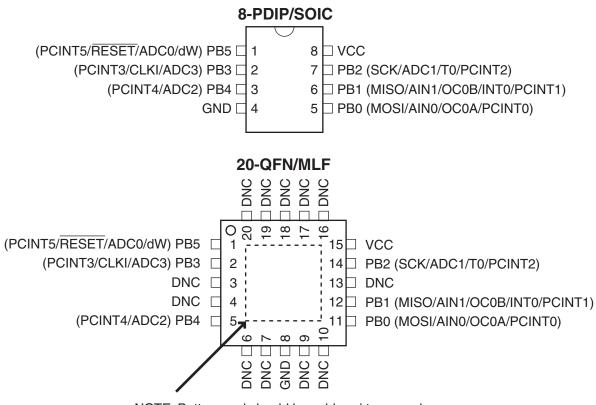


Rev. 8126FS-AVR-05/12



1. Pin Configurations

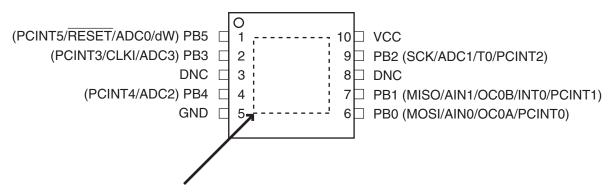
Figure 1-1. Pinout of ATtiny13A



NOTE: Bottom pad should be soldered to ground.

DNC: Do Not Connect

10-QFN/MLF



NOTE: Bottom pad should be soldered to ground.

DNC: Do Not Connect

1.1 Pin Description

1.1.1 VCC

Supply voltage.

1.1.2 GND

Ground.

1.1.3 Port B (PB5:PB0)

Port B is a 6-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port B output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port B pins that are externally pulled low will source current if the pull-up resistors are activated. The Port B pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port B also serves the functions of various special features of the ATtiny13A as listed on page 55.

1.1.4 **RESET**

Reset input. A low level on this pin for longer than the minimum pulse length will generate a reset, even if the clock is not running and provided the reset pin has not been disabled. The minimum pulse length is given in Table 18-4 on page 120. Shorter pulses are not guaranteed to generate a reset.

The reset pin can also be used as a (weak) I/O pin.



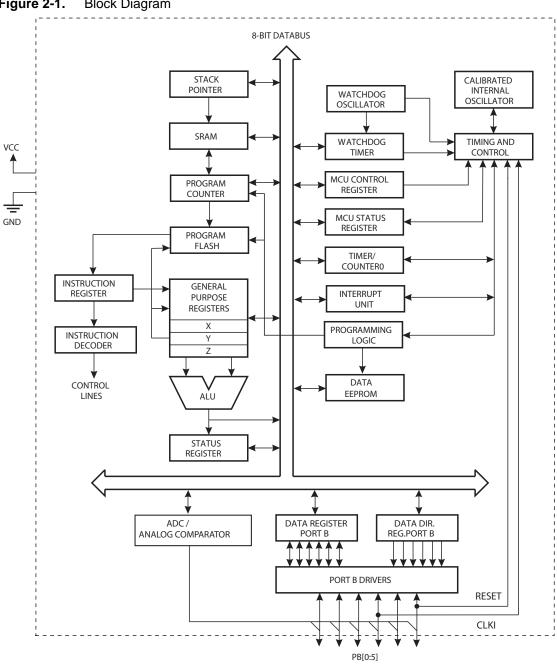


2. **Overview**

The ATtiny13A is a low-power CMOS 8-bit microcontroller based on the AVR enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATtiny13A achieves throughputs approaching 1 MIPS per MHz allowing the system designer to optimize power consumption versus processing speed.

2.1 **Block Diagram**

Figure 2-1. **Block Diagram**



The AVR core combines a rich instruction set with 32 general purpose working registers. All 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs up to ten times faster than conventional CISC microcontrollers.

The ATtiny13A provides the following features: 1K byte of In-System Programmable Flash, 64 bytes EEPROM, 64 bytes SRAM, 6 general purpose I/O lines, 32 general purpose working registers, one 8-bit Timer/Counter with compare modes, Internal and External Interrupts, a 4-channel, 10-bit ADC, a programmable Watchdog Timer with internal Oscillator, and three software selectable power saving modes. The Idle mode stops the CPU while allowing the SRAM, Timer/Counter, ADC, Analog Comparator, and Interrupt system to continue functioning. The Power-down mode saves the register contents, disabling all chip functions until the next Interrupt or Hardware Reset. The ADC Noise Reduction mode stops the CPU and all I/O modules except ADC, to minimize switching noise during ADC conversions.

The device is manufactured using Atmel's high density non-volatile memory technology. The On-chip ISP Flash allows the Program memory to be re-programmed In-System through an SPI serial interface, by a conventional non-volatile memory programmer or by an On-chip boot code running on the AVR core.

The ATtiny13A AVR is supported with a full suite of program and system development tools including: C Compilers, Macro Assemblers, Program Debugger/Simulators, and Evaluation kits.





3. About

3.1 Resources

A comprehensive set of drivers, application notes, data sheets and descriptions on development tools are available for download at http://www.atmel.com/avr.

3.2 Code Examples

This documentation contains simple code examples that briefly show how to use various parts of the device. These code examples assume that the part specific header file is included before compilation. Be aware that not all C compiler vendors include bit definitions in the header files and interrupt handling in C is compiler dependent. Please confirm with the C compiler documentation for more details.

3.3 Data Retention

Reliability Qualification results show that the projected data retention failure rate is much less than 1 PPM over 20 years at 85°C or 100 years at 25°C.

4. Register Summary

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
0x3F	SREG	I	T	Н	S	V	N	Z	С	page 9
0x3E	Reserved	-	_	-	-	-	_	-	-	
0x3D	SPL				SP	[7:0]				page 11
0x3C	Reserved	-	-	-	-	-	_	-	-	
0x3B	GIMSK	-	INT0	PCIE	-	-	_	-	_	page 47
0x3A	GIFR	-	INTF0	PCIF	-	-	-	-	-	page 48
0x39	TIMSK0	-	-	-	-	OCIE0B	OCIE0A	TOIE0	-	page 75
0x38	TIFR0	-	_	-	-	OCF0B	OCF0A	TOV0	-	page 76
0x37	SPMCSR	-	_	-	СТРВ	RFLB	PGWRT	PGERS	SELFPR-	page 98
0x36	OCR0A			Timer	/Counter - Outp	ut Compare Reg	ister A			page 75
0x35	MCUCR	_	PUD	SE	SM1	SM0	_	ISC01	ISC00	pages 33, 47, 57
0x34	MCUSR	_	-	_	-	WDRF	BORF	EXTRF	PORF	page 42
0x33	TCCR0B	FOC0A	FOC0B	_	-	WGM02	CS02	CS01	CS00	page 73
0x32	TCNT0				Timer/Co	unter (8-bit)				page 74
0x31	OSCCAL				Oscillator Cali	bration Register				page 27
0x30	BODCR	-	_	-	-	-	_	BODS	BODSE	page 33
0x2F	TCCR0A	COM0A1	COM0A0	COM0B1	COM0B0	_	_	WGM01	WGM00	page 70
0x2E	DWDR				DWD	PR[7:0]	•	•		page 97
0x2D	Reserved					=				
0x2C	Reserved					_				
0x2B	Reserved					_				
0x2A	Reserved					_				
0x29	OCR0B			Timer	/Counter – Outo	ut Compare Reg	ister B			page 75
0x28	GTCCR	TSM	_	-		–	-	_	PSR10	page 78
0x27	Reserved	10111		1	I	_	l	I	1 01(10	page 10
0x26	CLKPR	CLKPCE	_	_	I -	CLKPS3	CLKPS2	CLKPS1	CLKPS0	page 28
0x25	PRR	-		_	-	- -	- CLRF32	PRTIM0	PRADC	
0x24	Reserved	_		_		_	_	PKIIIVIU	PRADC	page 34
	ł									
0x23	Reserved					_				
0x22	Reserved	MOTIF	WETE	LANDES			I WDDs	14/004	MADDO	
0x21	WDTCR	WDTIF	WDTIE	WDP3	WDCE	WDE	WDP2	WDP1	WDP0	page 42
0x20	Reserved					_				
0x1F	Reserved									
0x1E	EEARL	-	_				dress Register			page 20
0x1D	EEDR					Data Register	1			page 20
0x1C	EECR	_	_	EEPM1	EEPM0	EERIE	EEMPE	EEPE	EERE	page 21
0x1B	Reserved									
0x1A	Reserved					_				
0x19	Reserved					-				
0x18	PORTB	-		PORTB5	PORTB4	PORTB3	PORTB2	PORTB1	PORTB0	page 57
0x17	DDRB	-		DDB5	DDB4	DDB3	DDB2	DDB1	DDB0	page 57
0x16	PINB	_	-	PINB5	PINB4	PINB3	PINB2	PINB1	PINB0	page 58
0x15	PCMSK	_	-	PCINT5	PCINT4	PCINT3	PCINT2	PCINT1	PCINT0	page 48
0x14	DIDR0	-	-	ADC0D	ADC2D	ADC3D	ADC1D	AIN1D	AIN0D	pages 81, 95
0x13	Reserved									
0x12	Reserved					_				
0x11	Reserved					_				
0x10	Reserved					_				
0x0F	Reserved									
0x0E	Reserved									
0x0D	Reserved									
	Reserved					_				
0x0C						_				
0x0C 0x0B	Reserved									
0x0B	Reserved Reserved									
0x0B 0x0A	Reserved					_				
0x0B 0x0A 0x09	Reserved Reserved	ACD	ACPC	ACO				ACIS1	ACIEO	nogo 90
0x0B 0x0A 0x09 0x08	Reserved Reserved ACSR	ACD	ACBG	ACO	ACI	ACIE	-	ACIS1	ACISO	page 80
0x0B 0x0A 0x09 0x08 0x07	Reserved Reserved ACSR ADMUX	=	REFS0	ADLAR	ACI –	ACIE –	_	MUX1	MUX0	page 92
0x0B 0x0A 0x09 0x08 0x07	Reserved Reserved ACSR ADMUX ADCSRA				ACI - ADIF	ACIE - ADIE	- - ADPS2			page 92 page 93
0x0B 0x0A 0x09 0x08 0x07 0x06 0x05	Reserved Reserved ACSR ADMUX ADCSRA ADCH	=	REFS0	ADLAR	ACI ADIF ADC Data Re	ACIE - ADIE gister High Byte	_	MUX1	MUX0	page 92 page 93 page 94
0x0B 0x0A 0x09 0x08 0x07 0x06 0x05 0x04	Reserved Reserved ACSR ADMUX ADCSRA ADCH ADCL	ADEN	REFS0 ADSC	ADLAR ADATE	ACI ADIF ADC Data Re	ACIE ADIE gister High Byte gister Low Byte	ADPS2	MUX1 ADPS1	MUX0 ADPS0	page 92 page 93 page 94 page 94
0x0B 0x0A 0x09 0x08 0x07 0x06 0x05 0x04	Reserved Reserved ACSR ADMUX ADCSRA ADCH ADCL ADCSRB	=	REFS0	ADLAR	ACI ADIF ADC Data Re ADC Data Re	ACIE ADIE gister High Byte gister Low Byte -	_	MUX1	MUX0	page 92 page 93 page 94
0x0B 0x0A 0x09 0x08 0x07 0x06 0x05 0x04	Reserved Reserved ACSR ADMUX ADCSRA ADCH ADCL	ADEN	REFS0 ADSC	ADLAR ADATE	ACI ADIF ADC Data Rei ADC Data Rei ADC Data Rei	ACIE ADIE gister High Byte gister Low Byte	ADPS2	MUX1 ADPS1	MUX0 ADPS0	page 92 page 93 page 94 page 94





Notes: 1. For compatibility with future devices, reserved bits should be written to zero if accessed. Reserved I/O memory addresses should never be written.

2. I/O Registers within the address range 0x00 - 0x1F are directly bit-accessible using the SBI and CBI instructions. In these registers, the value of single bits can be checked by using the SBIS and SBIC instructions.ome of the Status Flags are cleared by writing a logical one to them. Note that, unlike most other AVRs, the CBI and SBI instructions will only operation the specified bit, and can therefore be used on registers containing such Status Flags. The CBI and SBI instructions work with registers 0x00 to 0x1F only.

5. Instruction Set Summary

Mnemonics	Operands	Description	Operation	Flags	#Clocks
	ARITHME	TIC AND LOGIC INSTRUCTIONS		-	
ADD	Rd, Rr	Add two Registers	Rd ← Rd + Rr	Z,C,N,V,H	1
ADC	Rd, Rr	Add with Carry two Registers	$Rd \leftarrow Rd + Rr + C$	Z,C,N,V,H	1
ADIW	Rdl,K	Add Immediate to Word	Rdh:Rdl ← Rdh:Rdl + K	Z,C,N,V,S	2
SUB	Rd, Rr	Subtract two Registers	Rd ← Rd - Rr	Z,C,N,V,H	1
SUBI	Rd, K	Subtract Constant from Register	Rd ← Rd - K	Z,C,N,V,H	1
SBC	Rd, Rr	Subtract with Carry two Registers	Rd ← Rd - Rr - C	Z,C,N,V,H	1
SBCI	Rd, K	Subtract with Carry Constant from Reg.	Rd ← Rd - K - C	Z,C,N,V,H	1
SBIW	Rdl,K	Subtract Immediate from Word	Rdh:Rdl ← Rdh:Rdl - K	Z,C,N,V,S	2
AND	Rd, Rr	Logical AND Registers	$Rd \leftarrow Rd \bullet Rr$	Z,N,V	1
ANDI	Rd, K	Logical AND Register and Constant	$Rd \leftarrow Rd \bullet K$	Z,N,V	1
OR	Rd, Rr	Logical OR Registers	Rd ← Rd v Rr	Z,N,V	1
ORI	Rd, K	Logical OR Register and Constant	Rd ← Rd v K	Z,N,V	1
EOR	Rd, Rr	Exclusive OR Registers	$Rd \leftarrow Rd \oplus Rr$	Z,N,V	1
COM	Rd	One's Complement	Rd ← 0xFF – Rd	Z,C,N,V	1
NEG	Rd	Two's Complement	Rd ← 0x00 – Rd	Z,C,N,V,H	1
SBR	Rd,K	Set Bit(s) in Register	Rd ← Rd v K	Z,N,V	1
CBR	Rd,K	Clear Bit(s) in Register	$Rd \leftarrow Rd \bullet (0xFF - K)$	Z,N,V	1
INC	Rd	Increment	Rd ← Rd + 1	Z,N,V	1
DEC	Rd	Decrement	Rd ← Rd − 1	Z,N,V	1
TST	Rd	Test for Zero or Minus	$Rd \leftarrow Rd \bullet Rd$	Z,N,V	1
					+
CLR	Rd	Clear Register	$Rd \leftarrow Rd \oplus Rd$	Z,N,V	1
SER	Rd	Set Register	$Rd \leftarrow 0xFF$	None	1
	ı	RANCH INSTRUCTIONS	T	_	T
RJMP	k	Relative Jump	PC ← PC + k + 1	None	2
IJMP		Indirect Jump to (Z)	PC ← Z	None	2
RCALL	k	Relative Subroutine Call	PC ← PC + k + 1	None	3
ICALL		Indirect Call to (Z)	PC ← Z	None	3
RET		Subroutine Return	PC ← STACK	None	4
RETI		Interrupt Return	PC ← STACK	1	4
CPSE	Rd,Rr	Compare, Skip if Equal	if (Rd = Rr) PC ← PC + 2 or 3	None	1/2/3
СР	Rd,Rr	Compare	Rd – Rr	Z, N,V,C,H	1
CPC	Rd,Rr	Compare with Carry	Rd – Rr – C	Z, N,V,C,H	1
CPI	Rd,K	Compare Register with Immediate	Rd – K	Z, N,V,C,H	1
SBRC	Rr, b	Skip if Bit in Register Cleared	if (Rr(b)=0) PC ← PC + 2 or 3	None	1/2/3
SBRS	Rr, b	Skip if Bit in Register is Set	if $(Rr(b)=1)$ PC \leftarrow PC + 2 or 3	None	1/2/3
SBIC	P, b	Skip if Bit in I/O Register Cleared	if (P(b)=0) PC \leftarrow PC + 2 or 3	None	1/2/3
SBIS	P, b	Skip if Bit in I/O Register is Set	if $(P(b)=1)$ PC \leftarrow PC + 2 or 3	None	1/2/3
BRBS	s, k	Branch if Status Flag Set	if (SREG(s) = 1) then PC←PC+k + 1	None	1/2
BRBC		Branch if Status Flag Cleared	if (SREG(s) = 0) then PC←PC+k + 1	None	1/2
BREQ	s, k	•	, , , ,		1/2
	k	Branch if Equal	if (Z = 1) then PC ← PC + k + 1	None	
BRNE	k	Branch if Not Equal	if (Z = 0) then PC ← PC + k + 1	None	1/2
BRCS	k	Branch if Carry Set	if (C = 1) then PC ← PC + k + 1	None	1/2
BRCC	k	Branch if Carry Cleared	if (C = 0) then PC \leftarrow PC + k + 1	None	1/2
BRSH	k	Branch if Same or Higher	if (C = 0) then PC \leftarrow PC + k + 1	None	1/2
BRLO	k	Branch if Lower	if (C = 1) then PC ← PC + k + 1	None	1/2
BRMI	k	Branch if Minus	if (N = 1) then PC \leftarrow PC + k + 1	None	1/2
BRPL	k	Branch if Plus	if (N = 0) then PC \leftarrow PC + k + 1	None	1/2
BRGE	k	Branch if Greater or Equal, Signed	if $(N \oplus V= 0)$ then PC \leftarrow PC + k + 1	None	1/2
BRLT	k	Branch if Less Than Zero, Signed	if (N \oplus V= 1) then PC \leftarrow PC + k + 1	None	1/2
BRHS	k	Branch if Half Carry Flag Set	if (H = 1) then PC \leftarrow PC + k + 1	None	1/2
BRHC	k	Branch if Half Carry Flag Cleared	if (H = 0) then PC \leftarrow PC + k + 1	None	1/2
BRTS	k	Branch if T Flag Set	if (T = 1) then PC \leftarrow PC + k + 1	None	1/2
BRTC	k	Branch if T Flag Cleared	if (T = 0) then PC ← PC + k + 1	None	1/2
BRVS	k	Branch if Overflow Flag is Set	if (V = 1) then PC ← PC + k + 1	None	1/2
BRVC	k	Branch if Overflow Flag is Cleared	if (V = 0) then PC ← PC + k + 1	None	1/2
BRIE	k	Branch if Interrupt Enabled	if (I = 1) then PC ← PC + k + 1	None	1/2
BRID	k	Branch if Interrupt Disabled	if (I = 0) then PC ← PC + k + 1	None	1/2
טואוט		D BIT-TEST INSTRUCTIONS	(= 0)	INUITE	1/2
SBI	P,b	Set Bit in I/O Register	I/O/P b) / 4	None	2
			I/O(P,b) ← 1		1
CBI	P,b	Clear Bit in I/O Register	$I/O(P,b) \leftarrow 0$	None	2
LSL	Rd	Logical Shift Left	$Rd(n+1) \leftarrow Rd(n), Rd(0) \leftarrow 0$	Z,C,N,V	1
LSR	Rd	Logical Shift Right	$Rd(n) \leftarrow Rd(n+1), Rd(7) \leftarrow 0$	Z,C,N,V	1
ROL	Rd	Rotate Left Through Carry	$Rd(0)\leftarrow C,Rd(n+1)\leftarrow Rd(n),C\leftarrow Rd(7)$	Z,C,N,V	1





Mnemonics	Operands	Description	Operation	Flags	#Clocks
ROR	Rd	Rotate Right Through Carry	$Rd(7)\leftarrow C,Rd(n)\leftarrow Rd(n+1),C\leftarrow Rd(0)$	Z,C,N,V	1
ASR	Rd	Arithmetic Shift Right	$Rd(n) \leftarrow Rd(n+1), n=06$	Z,C,N,V	1
SWAP	Rd	Swap Nibbles	Rd(30)←Rd(74),Rd(74)←Rd(30)	None	1
BSET	S	Flag Set	SREG(s) ← 1	SREG(s)	1
BCLR	s	Flag Clear	SREG(s) ← 0	SREG(s)	1
BST	Rr, b	Bit Store from Register to T	$T \leftarrow Rr(b)$	T	1
BLD	Rd, b	Bit load from T to Register	$Rd(b) \leftarrow T$	None	1
SEC		Set Carry	C ← 1	С	1
CLC		Clear Carry	C ← 0	С	1
SEN		Set Negative Flag	N ← 1	N	1
CLN		Clear Negative Flag	N ← 0	N	1
SEZ		Set Zero Flag	Z ← 1	Z	1
CLZ		Clear Zero Flag	Z ← 0	Z	1
SEI		Global Interrupt Enable	I ← 1	1	1
CLI		Global Interrupt Disable	1←0	1	1
SES		Set Signed Test Flag	S ← 1	S	1
CLS		Clear Signed Test Flag	S ← 0	S	1
SEV		Set Twos Complement Overflow.	V ← 1	V	1
CLV		Clear Twos Complement Overflow	V ← 0	V	1
SET		Set T in SREG	T ← 1	Т	1
CLT		Clear T in SREG	T ← 0	T T	1
SEH		Set Half Carry Flag in SREG	H ← 1	Н	1
CLH		Clear Half Carry Flag in SREG	H ← 0	Н	1
OLIT	DATA TPA	NSFER INSTRUCTIONS			1
MOV	Rd, Rr	Move Between Registers	Rd ← Rr	None	1
MOVW			$Rd \leftarrow RI$ $Rd+1:Rd \leftarrow Rr+1:Rr$	None	1
	Rd, Rr	Copy Register Word			1
LDI	Rd, K	Load Immediate	Rd ← K	None	1
LD	Rd, X	Load Indirect	$Rd \leftarrow (X)$	None	2
LD	Rd, X+	Load Indirect and Post-Inc.	$Rd \leftarrow (X), X \leftarrow X + 1$	None	2
LD	Rd, - X	Load Indirect and Pre-Dec.	$X \leftarrow X - 1$, $Rd \leftarrow (X)$	None	2
LD	Rd, Y	Load Indirect	$Rd \leftarrow (Y)$	None	2
LD	Rd, Y+	Load Indirect and Post-Inc.	$Rd \leftarrow (Y), Y \leftarrow Y + 1$	None	2
LD	Rd, - Y	Load Indirect and Pre-Dec.	$Y \leftarrow Y - 1$, $Rd \leftarrow (Y)$	None	2
LDD	Rd,Y+q	Load Indirect with Displacement	$Rd \leftarrow (Y + q)$	None	2
LD	Rd, Z	Load Indirect	$Rd \leftarrow (Z)$	None	2
LD	Rd, Z+	Load Indirect and Post-Inc.	$Rd \leftarrow (Z), Z \leftarrow Z+1$	None	2
LD	Rd, -Z	Load Indirect and Pre-Dec.	$Z \leftarrow Z - 1$, $Rd \leftarrow (Z)$	None	2
LDD	Rd, Z+q	Load Indirect with Displacement	$Rd \leftarrow (Z + q)$	None	2
LDS	Rd, k	Load Direct from SRAM	Rd ← (k)	None	2
ST	X, Rr	Store Indirect	$(X) \leftarrow Rr$	None	2
ST	X+, Rr	Store Indirect and Post-Inc.	$(X) \leftarrow Rr, X \leftarrow X + 1$	None	2
ST	- X, Rr	Store Indirect and Pre-Dec.	$X \leftarrow X - 1$, $(X) \leftarrow Rr$	None	2
ST	Y, Rr	Store Indirect	$(Y) \leftarrow Rr$	None	2
ST	Y+, Rr	Store Indirect and Post-Inc.	$(Y) \leftarrow Rr, Y \leftarrow Y + 1$	None	2
ST	- Y, Rr	Store Indirect and Pre-Dec.	$Y \leftarrow Y - 1$, $(Y) \leftarrow Rr$	None	2
STD	Y+q,Rr	Store Indirect with Displacement	$(Y + q) \leftarrow Rr$	None	2
ST	Z, Rr	Store Indirect	(Z) ← Rr	None	2
ST	Z+, Rr	Store Indirect and Post-Inc.	$(Z) \leftarrow Rr, Z \leftarrow Z + 1$	None	2
ST	-Z, Rr	Store Indirect and Pre-Dec.	$Z \leftarrow Z - 1$, $(Z) \leftarrow Rr$	None	2
STD	Z+q,Rr	Store Indirect with Displacement	(Z + q) ← Rr	None	2
STS	k, Rr	Store Direct to SRAM	(k) ← Rr	None	2
LPM		Load Program Memory	R0 ← (Z)	None	3
LPM	Rd, Z	Load Program Memory	$Rd \leftarrow (Z)$	None	3
LPM	Rd, Z+	Load Program Memory and Post-Inc	$Rd \leftarrow (Z), Z \leftarrow Z+1$	None	3
SPM		Store Program Memory	(z) ← R1:R0	None	
IN	Rd, P	In Port	Rd ← P	None	1
OUT	P, Rr	Out Port	P ← Rr	None	1
PUSH	Rr	Push Register on Stack	STACK ← Rr	None	2
POP	Rd	Pop Register from Stack	Rd ← STACK	None	2
, 01		ITROL INSTRUCTIONS	I INT COLUMN	INOIG	
NOP	IVICO COIN	No Operation		None	1
INOF		·	('5' (0' ('5')		
	l	Sloop			
SLEEP WDR		Sleep Watchdog Reset	(see specific descr. for Sleep function) (see specific descr. for WDR/Timer)	None None	1

6. Ordering Information

Speed (MHz)	Power Supply (V)	Ordering Code ⁽¹⁾	Package ⁽²⁾	Operation Range
20	1.8 - 5.5	ATtiny13A-PU ATtiny13A-SU ATtiny13A-SUR ATtiny13A-SH ATtiny13A-SSU ATtiny13A-SSU ATtiny13A-SSUR ATtiny13A-SSH ATtiny13A-SSH ATtiny13A-MU ATtiny13A-MUR ATtiny13A-MUR ATtiny13A-MMUR(3) ATtiny13A-MMUR(3)	8P3 8S2 8S2 8S2 8S2 8S1 8S1 8S1 20M1 20M1 10M1 ⁽³⁾	Industrial (-40°C to +85°C) ⁽⁴⁾
		ATtiny13A-SN ATtiny13A-SNR ATtiny13A-SS7 ATtiny13A-SS7R	8S2 8S2 8S1 8S1	Industrial (-40°C to +105°C) ⁽⁵⁾
		ATtiny13A-SF ATtiny13A-SFR ATtiny13A-MMF ATtiny13A-MMFR	8S2 8S2 10M1 ⁽³⁾ 10M1 ⁽³⁾	Industrial (-40°C to +125°C) ⁽⁶⁾

Notes: 1. Code indicators:

- H or 7: NiPdAu lead finish

- U, N or F: matte tin

- R: tape & reel

- 2. All packages are Pb-free, halide-free and fully green and they comply with the European directive for Restriction of Hazard-ous Substances (RoHS).
- 3. Topside marking for ATtiny13A:

1st Line: T132nd Line: Axx3rd Line: xxx

- 4. These devices can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
- 5. For typical and Electrical characteristics for this device please consult Appendix A, ATtiny13A Specification at 105°C.
- 6. For typical and Electrical characteristics for this device please consult Appendix B, ATtiny13A Specification at 125°C.

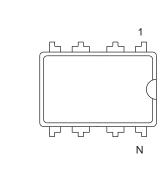
Package Type					
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)				
8S2 8-lead, 0.209" Wide, Plastic Small Outline Package (EIAJ SOIC)					
8-lead, 0.150" Wide, Plastic Gull-Wing Small Outline (JEDEC SOIC)					
20M1	20-pad, 4 x 4 x 0.8 mm Body, Lead Pitch 0.50 mm, Micro Lead Frame Package (MLF)				
10M1	10-pad, 3 x 3 x 1 mm Body, Lead Pitch 0.50 mm, Micro Lead Frame Package (MLF)				



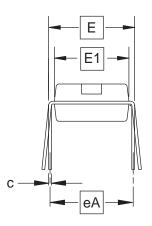


Packaging Information

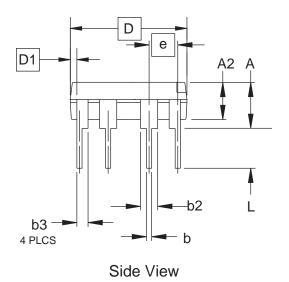
7.1 **8P3**



Top View



End View



COMMON DIMENSIONS

(Unit of Measure = inches)

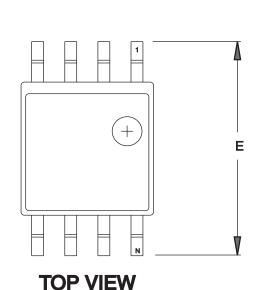
SYMBOL	MIN	NOM	MAX	NOTE
А			0.210	2
A2	0.115	0.130	0.195	
b	0.014	0.018	0.022	5
b2	0.045	0.060	0.070	6
b3	0.030	0.039	0.045	6
С	0.008	0.010	0.014	
D	0.355	0.365	0.400	3
D1	0.005			3
Е	0.300	0.310	0.325	4
E1	0.240	0.250	0.280	3
е	(
eA	0.300 BSC			4
L	0.115	0.130	0.150	2

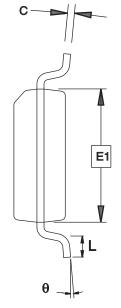
- This drawing is for general information only; refer to JEDEC Drawing MS-001, Variation BA for additional information.
 Dimensions A and L are measured with the package seated in JEDEC seating plane Gauge GS-3.
- 3. D, D1 and E1 dimensions do not include mold Flash or protrusions. Mold Flash or protrusions shall not exceed 0.010 inch.
- 4. E and eA measured with the leads constrained to be perpendicular to datum.
- 5. Pointed or rounded lead tips are preferred to ease insertion.
- 6. b2 and b3 maximum dimensions do not include Dambar protrusions. Dambar protrusions shall not exceed 0.010 (0.25 mm).

01/09/02

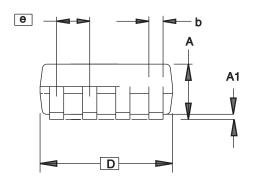
l		TITLE	DRAWING NO.	REV.
<u>Alm</u>	2325 Orchard Parkway San Jose, CA 95131	8P3, 8-lead, 0.300" Wide Body, Plastic Dual In-line Package (PDIP)	8P3	В

7.2 **8S2**





END VIEW



COMMON DIMENSIONS (Unit of Measure = mm)

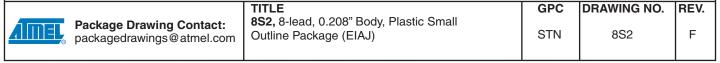
SYMBOL	MIN	NOM	MAX	NOTE
Α	1.70		2.16	
A1	0.05		0.25	
b	0.35		0.48	4
С	0.15		0.35	4
D	5.13		5.35	
E1	5.18		5.40	2
E	7.70		8.26	
L	0.51		0.85	
θ	0°		8°	
е		1.27 BSC		3

SIDE VIEW

- Notes: 1. This drawing is for general information only; refer to EIAJ Drawing EDR-7320 for additional information.
 - 2. Mismatch of the upper and lower dies and resin burrs aren't included.

 - Determines the true geometric position.
 Values b,C apply to plated terminal. The standard thickness of the plating layer shall measure between 0.007 to .021 mm.

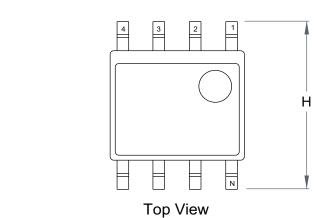
4/15/08

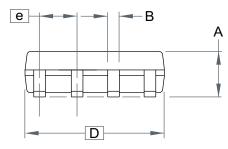




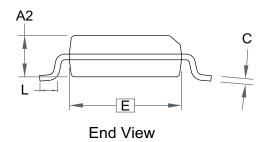


7.3 **8S1**





Side View



COMMON DIMENSIONS

(Unit of Measure = mm)

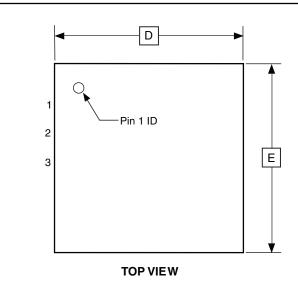
SYMBOL	MIN	NOM	MAX	NOTE
Α	_	_	1.75	
В	_	_	0.51	
С	_	_	0.25	
D	_	-	5.00	
Е	_	_	4.00	
е		1.27 BSC		
Н	_	_	6.20	
L	_	_	1.27	

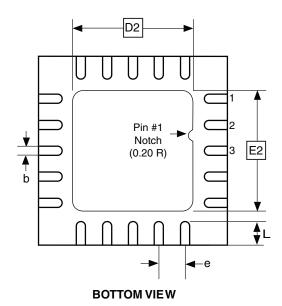
Note: This drawing is for general information only. Refer to JEDEC Drawing MS-012 for proper dimensions, tolerances, datums, etc.

2010-10-20

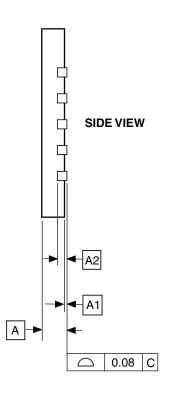
<u>AIMEL</u>	2325 Orchard Parkway San Jose, CA 95131	TITLE 8S1, 8-lead (0.150" Wide Body), Plastic Gull Wing Small Outline (JEDEC SOIC)	8S1	REV. B

7.4 20M1





Note: Reference JEDEC Standard MO-220, Fig. 1 (SAW Singulation) WGGD-5.



COMMON DIMENSIONS

(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE	
Α	0.70	0.75	0.80		
A1	_	0.01	0.05		
A2		0.20 REF			
b	0.18	0.23	0.30		
D		4.00 BSC			
D2	2.45	2.60	2.75		
Е		4.00 BSC			
E2	2.45	2.60	2.75		
е	0.50 BSC				
L	0.35	0.40	0.55		

10/27/04



2325 Orchard Parkway San Jose, CA 95131 **TITLE 20M1**, 20-pad, 4 x 4 x 0.8 mm Body, Lead Pitch 0.50 mm, 2.6 mm Exposed Pad, Micro Lead Frame Package (MLF)

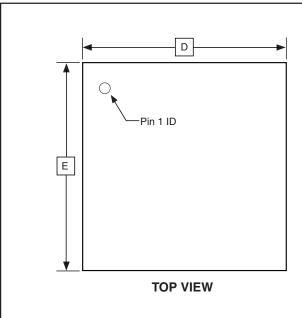
DRAWING NO. 20M1

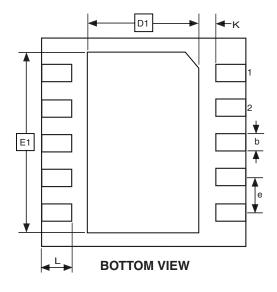
REV.

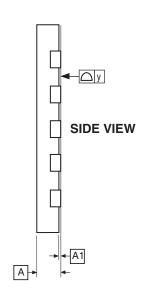




7.5 10M1







COMMON DIMENSIONS (Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	0.80	0.90	1.00	
A1	0.00	0.02	0.05	
b	0.18	0.25	0.30	
D	2.90	3.00	3.10	
D1	1.40	_	1.75	
E	2.90	3.00	3.10	
E1	2.20	_	2.70	
е	0.50			
L	0.30	_	0.50	
у	_	_	0.08	
K	0.20	_	_	

Notes: 1. This package conforms to JEDEC reference MO-229C, Variation VEED-5.

2. The terminal #1 ID is a Lasser-marked Feature.

7/7/06 **D. IREV.**

<u>AMEL</u>	232 San
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2325 Orchard Parkway San Jose, CA 95131 10M1, 10-pad, 3 x 3 x 1.0 mm Body, Lead Pitch 0.50 mm, 1.64 x 2.60 mm Exposed Pad, Micro Lead Frame Package

DRAWING NO. 10M1

Α

8. Errata

The revision letters in this section refer to the revision of the ATtiny13A device.

8.1 ATtiny13A Rev. G – H

• EEPROM can not be written below 1.9 Volt

1. EEPROM can not be written below 1.9 Volt

Writing the EEPROM at V_{CC} below 1.9 volts might fail.

Problem Fix/Workaround

Do not write the EEPROM when V_{CC} is below 1.9 volts.

8.2 ATtiny13A Rev. E – F

These device revisions were not sampled.

8.3 ATtiny13 Rev. A – D

These device revisions were referred to as ATtiny13/ATtiny13V.





9. Datasheet Revision History

Please note that page numbers in this section refer to the current version of this document and may not apply to previous versions.

9.1 Rev. 8126F - 05/12

- 1. Updated Table 10-5 on page 57.
- 2. Updated order codes on page 11.

9.2 Rev. 8126E - 07/10

- 1. Updated description in Section 6.4.2 "CLKPR Clock Prescale Register" on page 28.
- 2. Adjusted notes in Table 18-1, "DC Characteristics, TA = -40°C to +85°C," on page 117.
- 3. Updated plot order in Section 19. "Typical Characteristics" on page 124, added some plots, also some headers and figure titles adjusted.
- 4. Updated Section 6. "Ordering Information" on page 11, added extended temperature part numbers, as well tape & reel part numbers. Notes adjusted.
- 5. Updated bit syntax throughout the datasheet, e.g. from CS02:0 to CS0[2:0].

9.3 Rev. 8126D - 11/09

- 1. Added note "If the RSTDISPL fuse is programmed..." in Startup-up Times Table 6-5 and Table 6-6 on page 26.
- 2. Added addresses in all Register Description tables and cross-references to Register Summary.
- 3. Updated naming convention for -COM bits in tables from Table 11-2 on page 70 to Table 11-7 on page 72.
- 4. Updated value for t_{WD_ERASE} in Table 17-8, "Minimum Wait Delay Before Writing the Next Flash or EEPROM Location," on page 108.
- 5. Added NiPdAU note for -SH and -SSH in Section 6. "Ordering Information" on page 11.

9.4 Rev. 8126C - 09/09

- 1. Added EEPROM errata for rev. G H on page 17.
- 2. Added a note about topside marking in Section 6. "Ordering Information" on page 11.

9.5 Rev. 8126B - 11/08

- 1. Updated order codes on page 11 to reflect changes in material composition.
- 2. Updated sections:
 - "DIDR0 Digital Input Disable Register 0" on page 81
 - "DIDR0 Digital Input Disable Register 0" on page 95
- 3. Updated "Register Summary" on page 7.

9.6 Rev. 8126A - 05/08

- 1. Initial revision, created from document 2535I 04/08.
- 2. Updated characteristic plots of section "Typical Characteristics", starting on page 124.
- 3. Updated "Ordering Information" on page 11.
- 4. Updated section:
 - "Speed" on page 118

- 5. Update tables:
 - "DC Characteristics, TA = -40°C to +85°C" on page 117
 - "Calibration Accuracy of Internal RC Oscillator" on page 119
 - "Reset, Brown-out, and Internal Voltage Characteristics" on page 120
 - "ADC Characteristics, Single Ended Channels. TA = -40°C to +85°C" on page 121
 - "Serial Programming Characteristics, TA = -40°C to +85°C" on page 122
- 6. Added description of new function, "Power Reduction Register":
 - Added functional description on page 31
 - Added bit description on page 34
 - Added section "Supply Current of I/O Modules" on page 124
 - Updated Register Summary on page 7
- 7. Added description of new function, "Software BOD Disable":
 - Added functional description on page 31
 - Updated section on page 32
 - Added register description on page 33
 - Updated Register Summary on page 7
- 8. Added description of enhanced function, "Enhanced Power-On Reset":
 - Updated Table 18-4 on page 120, and Table 18-5 on page 120





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